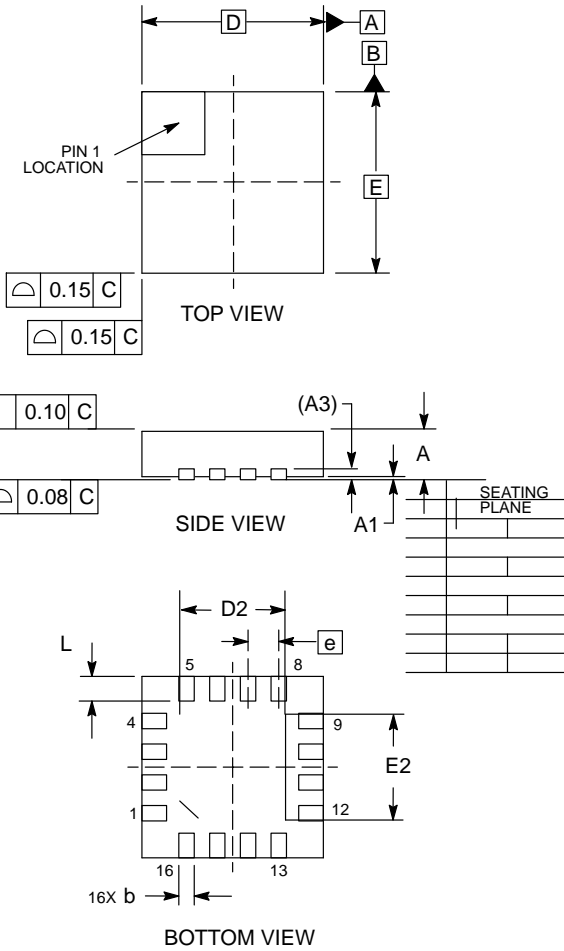




QFN16 3\*3\*0.75 MM, 0.5 P  
CASE 488AK i01  
ISSUE O

DATE 13 SEP 2004

SCALE 2:1



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION  $b$  APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
5.  $L_{max}$  CONDITION CAN NOT VIOLATE 0.2 MM SPACING BETWEEN LEAD TIP AND FLAG.

A1	0.00	0.05
A3	0.20	REF
b	0.18	0.30

GENERIC MARKING DIAGRAM\*

16  
1

XXXX  
XXXX  
ALYW

- XXXX = Specific Device Code
- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week

\*This information is generic. Please refer to device data sheet for actual part marking. Pb iFree indicator, "G", may or not be present.